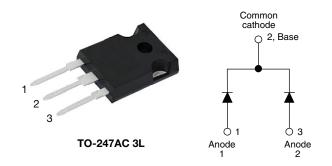


Hyperfast Rectifier, 2 x 40 A FRED Pt®



PRIMARY CHARACTERISTICS						
I _{F(AV)}	2 x 40 A					
V _R	300 V					
V _F at I _F	0.94 V					
t _{rr} typ.	34 ns					
T _J max.	175 °C					
Package	TO-247AC 3L					
Circuit configuration	Common cathode					

FEATURES

- · Hyperfast recovery time
- Low forward voltage drop
- · Low leakage current
- 175 °C operating junction temperature
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

RoHS COMPLIANT HALOGEN FREE

DESCRIPTIONS / APPLICATIONS

VS-80CPH03... series are the state of the art ultrafast recovery rectifiers designed with optimized performance of forward voltage drop and ultrafast recovery time.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in the output rectification stage of welding, SMPS, UPS, DC/DC converters as well as freewheeling diodes in low voltage inverters and chopper motor drives.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS		
Repetitive peak reverse voltage	V_{RRM}		300	V		
per leg		T _C = 133 °C	40			
Average rectified forward current total device	I _{F(AV)}	1C = 133 C	80	Α		
Non-repetitive peak surge current per leg	I _{FSM}	$T_J = 25 ^{\circ}\text{C}, t_p = 10 \text{ms}$	320			
Operating junction and storage temperatures	T _J , T _{Stg}		-65 to +175	°C		

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS MIN.		TYP.	MAX.	UNITS	
Breakdown voltage, blocking voltage	V _{BR} , V _R	Ι _R = 100 μΑ	300	-	-		
Forward voltage	V _F	I _F = 40 A	-	1.07	1.25	7 V	
		I _F = 40 A, T _J = 125 °C	-	0.94	1.10		
Poverse leekage eurrent	I _R	$V_R = V_R$ rated	-	-	10		
Reverse leakage current		T _J = 125 °C, V _R = V _R rated	-	-	300	μA	
Junction capacitance	C _T	V _R = 300 V		75	-	pF	
Series inductance	L _S	Measured lead to lead 5 mm from package body	ı	3.5	-	nH	



DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	TEST C	MIN.	TYP.	MAX.	UNITS		
		$I_F = 1.0 \text{ A}, di_F/dt = 1.0 \text{ A}$	100 A/μs, V _R = 30 V	-	34	-		
Reverse recovery time	+	$I_F = 1.0 \text{ A}, di_F/dt = 3$	$I_F = 1.0 \text{ A}, \text{ di}_F/\text{dt} = 50 \text{ A/}\mu\text{s}, \text{ V}_R = 30 \text{ V}$		-	35		
neverse recovery time	t _{rr}	T _J = 25 °C	$I_F = 40 \text{ A}$ $di_F/dt = -200 \text{ A/}\mu\text{s}$ $V_R = 200 \text{ V}$	-	41	-	ns -	
		T _J = 125 °C		-	62	-		
Dools recovery as weent	I _{RRM}	T _J = 25 °C		-	3.3	-	A	
Peak recovery current		T _J = 125 °C		-	8.5	-		
Reverse recovery charge	Q _{rr}	T _J = 25 °C		-	68	-	200	
		T _J = 125 °C		-	265	-	nC	

THERMAL - MECHANICAL	SPECIFICA	ATIONS				
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Maximum junction and storage temperature range	T _J , T _{Stg}		-65	-	175	°C
Thermal resistance, junction to case per leg	R _{thJC}		-	0.47	0.80	
Thermal resistance, junction to ambient per leg	R _{thJA}	Typical socket mount	-	-	40	°C/W
Thermal resistance, case to heatsink	R _{thCS}	Mounting surface, flat, smooth and greased	-	0.4	-	
Weight			-	6.0	-	g
vveignt			-	0.22	-	oz.
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)
Marking device		Case style TO-247AC 3L	80CPH03			



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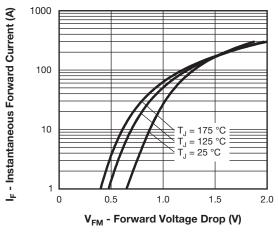


Fig. 1 - Typical Forward Voltage Drop Characteristics

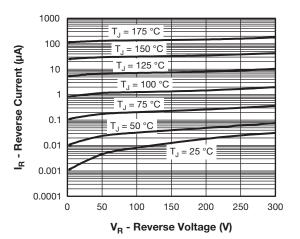


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

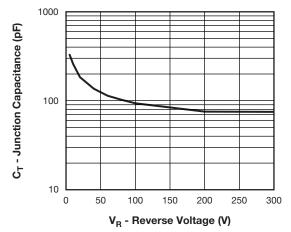


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

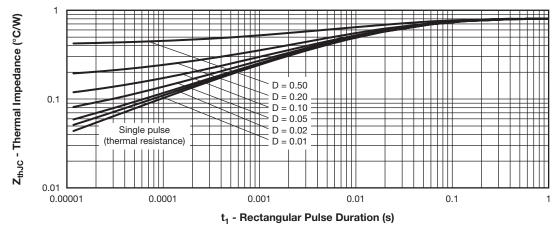


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics



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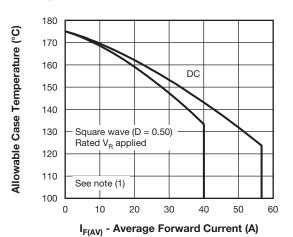


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

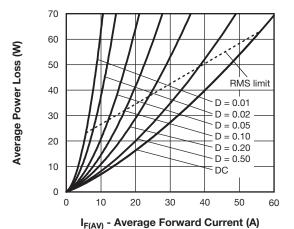


Fig. 6 - Forward Power Loss Characteristics

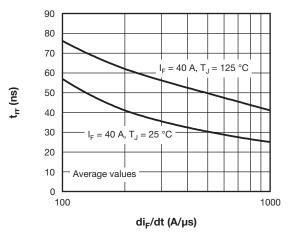


Fig. 7 - Typical Reverse Recovery Time vs. di_F/dt

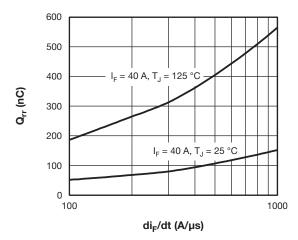


Fig. 8 - Typical Stored Charge vs. di_F/dt

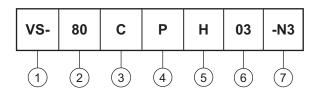
Note

 $^{(1)}$ Formula used: T_C = T_J - (Pd + Pd_{REV}) x R_{thJC}; Pd = forward power loss = I_{F(AV)} x V_{FM} at (I_{F(AV)}/D) (see fig. 6); Pd_{REV} = inverse power loss = V_{R1} x I_R (1 - D); I_R at V_{R1} = rated V_R



ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

- Current rating (80 = 80 A)

3 - Circuit configuration:

C = common cathode

4 - P = TO-247AC

5 - H = hyperfast rectifier

6 - Voltage rating (03 = 300 V)

7 - Environmental digit:

-N3 = halogen-free, RoHS-compliant and totally lead (Pb)-free

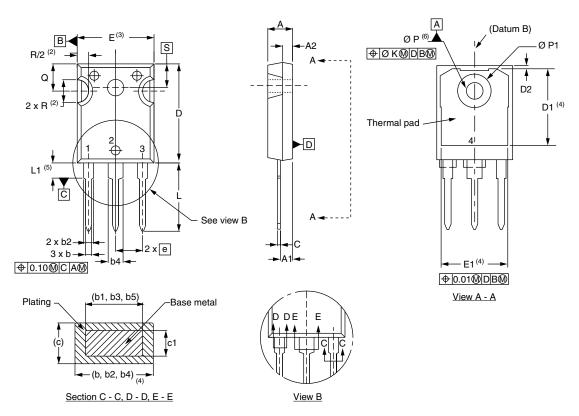
ORDERING INFORMATION (Example)						
PREFERRED P/N	QUANTITY PER TUBE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION			
VS-80CPH03-N3	25	500	Antistatic plastic tube			

LINKS TO RELATED DOCUMENTS					
Dimensions	www.vishay.com/doc?96138				
Part marking	www.vishay.com/doc?95007				



TO-247AC 3L

DIMENSIONS in millimeters and inches



SYMBOL	MILLIN	IETERS	INCHES		NOTES
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.17	1.37	0.046	0.054	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.34	0.065	0.092	
b4	2.59	3.43	0.102	0.135	
b5	2.59	3.38	0.102	0.133	
С	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4

SYMBOL	MILLIMETERS INCHES		NOTES		
STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
D2	0.51	1.35	0.020	0.053	
E	15.29	15.87	0.602	0.625	3
E1	13.46	-	0.53	-	
е	5.46	BSC	0.215	BSC	
ØK	0.2	0.254)10	
L	14.20	16.10	0.559	0.634	
L1	3.71	4.29	0.146	0.169	
ØΡ	3.56	3.66	0.14	0.144	
Ø P1	-	7.39	-	0.291	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51 BSC		0.217	BSC	

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension Q

Revision: 20-Jun-17 1 Document Number: 96138

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